# **SUPERRESOLUTION CONTOUR RECONSTRUCTION APPROACH** TO A LINEAR THERMAL EXPANSION MEASUREMENT

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## **Problem description (application)**

Linear thermal expansion (LTE) parameters are widely used to describe thermomechanical properties of materials. Optical LTE measurement principle is based on the sample's edge image processing by computing the edge displacement from two or more images obtained at different temperatures. Generally being a well-known problem, which can also be solved by existing image processing techniques, in this application it is sufficiently complexified by the following factors:

- 1. Edges of a sample obtained at different temperatures may slightly differ due to unexpected random edge distortions along with the expected linear expansion of the edge.
- Temperature range of the setup is up to 3000K. That requires long-distance microscopy (>400 mm object-to-lens distance), which leads to a limited optical resolution of integrated microscopes. Due to a phenomena known as **diffraction** optical resolution limit, small-sized features of the edge may not be resolved directly. For our system, spatial cutoff frequency is  $\approx$ 60um<sup>-1</sup>, while random edge distortions may be as small as 1..10 microns.
- Image of sample and background surfaces have **nonuniform** brightness, which leads to edge location error for the majority of conventional edge estimation techniques.
- Subpixel processing is required. 4.
- 5. Setup is a part of the primary national standard for the LTE coefficient and requires high-accuracy and reliable Non-reliable measurements must be measurements. **detected** and excluded from further processing.

- Up to 5x less error for random edge distortions factor; up to 4x less error for the nonuniformity factor.
- Two measurement reliability indicators are provided: realmodel images matching and contour-contour matching.

Comparison with digital image correlation (DIC) and conventional edge estimator based on *erf*-function fitting to the edge profile.

# Superresolution contour reconstruction (method)



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